Ferrites and accessories

EP 13
Core and accessories

Series/Type: **B65843A, B65844**

Date: May 2017

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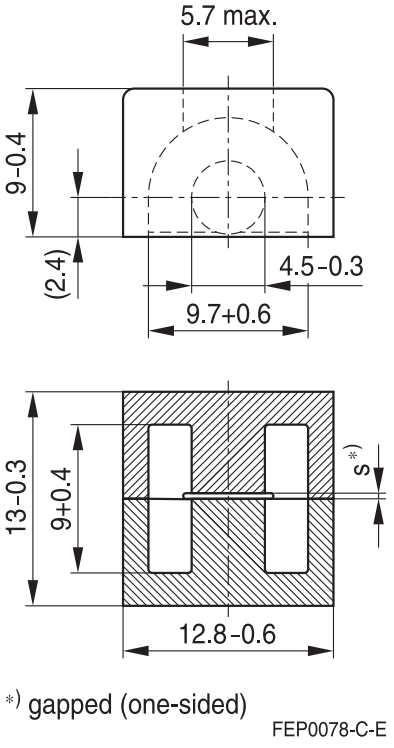
EP 13

Core B65843A

- To IEC 62317-5
- For transformers featuring high inductance and low overall height
- For power applications
- Delivery mode: sets



*) gapped (one-sided)

FEP0078-C-E

Magnetic characteristics (per set)

$\Sigma l/A$ = 1.24 mm^{-1}
l_e = 24.2 mm
A_e = 19.5 mm^2
A_{min} = 14.9 mm^2
V_e = 472 mm^3

Approx. weight 4.5 g/set

Gapped (A_L values/air gaps examples)

Material	A_L value nH	s approx. mm	μ_e	Ordering code
T38	63 ±3%	0.39	62	B65843A0063A038
	100 ±3%	0.24	99	B65843A0100A038
	160 ±4%	0.15	158	B65843A0160B038
	200 ±4%	0.12	198	B65843A0200B038
	250 ±5%	0.10	247	B65843A0250J038
	315 ±6%	0.08	311	B65843A0315C038
	400 ±7%	0.06	395	B65843A0400E038
T57	63 ±3%	0.38	62	B65843A0063A057
	100 ±3%	0.24	99	B65843A0100A057
	160 ±4%	0.15	158	B65843A0160B057
	200 ±4%	0.12	198	B65843A0200B057
	250 ±5%	0.09	247	B65843A0250J057
	315 ±6%	0.07	311	B65843A0315C057
	400 ±7%	0.06	395	B65843A0400E057
T66	63 ±3%	0.39	62	B65843A0063A066
	100 ±3%	0.24	99	B65843A0100A066
	160 ±4%	0.15	158	B65843A0160B066
	200 ±4%	0.12	198	B65843A0200B066
	250 ±5%	0.10	247	B65843A0250J066
	315 ±6%	0.08	311	B65843A0315C066
	400 ±7%	0.06	395	B65843A0400E066

Gapped

Material	A_L value nH	s approx. mm	μ_e	Ordering code
N45	63 ±3%	0.38	62	B65843A0063A045
	100 ±3%	0.24	99	B65843A0100A045
	160 ±4%	0.15	158	B65843A0160B045
	200 ±4%	0.12	198	B65843A0200B045
	250 ±5%	0.09	247	B65843A0250J045
	315 ±6%	0.07	311	B65843A0315C045
	400 ±7%	0.05	395	B65843A0400E045
N87	63 ±3%	0.37	62	B65843A0063A087
	100 ±3%	0.23	99	B65843A0100A087
	160 ±4%	0.14	158	B65843A0160B087
	200 ±4%	0.11	198	B65843A0200B087
	250 ±5%	0.09	247	B65843A0250J087
	315 ±6%	0.07	311	B65843A0315C087
	400 ±7%	0.05	395	B65843A0400E087

Ungapped

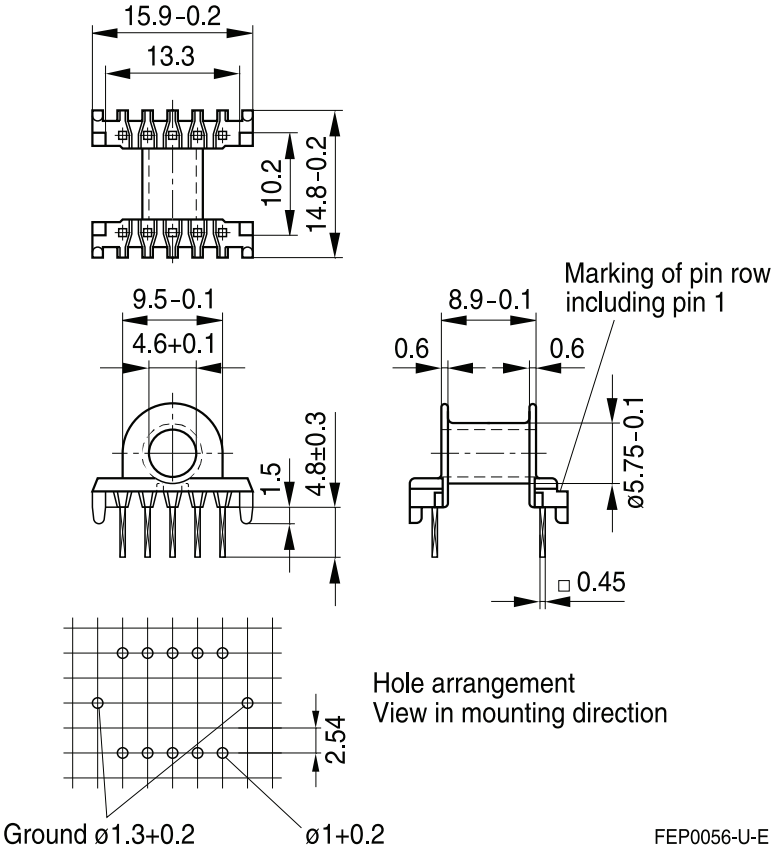
Material	A_L value nH	μ_e	P_V W/set	Ordering code
N45	2400 +30/–20%	2370		B65843A0000R045
T57	2500 +30/–20%	2470		B65843A0000R057
N30	2800 +30/–20%	2765		B65843A0000R030
T65	4000 +30/–20%	3950		B65843A0000R065
T38	7000 +40/–30%	6910		B65843A0000Y038
T66	8500 +40/–30%	8400		B65843A0000Y066
N49	1000 +30/–20%	990	< 0.06 (50 mT, 500 kHz, 100 °C)	B65843A0000R049
N87	1600 +30/–20%	1580	< 0.18 (200 mT, 100 kHz, 100 °C)	B65843A0000R087

Other A_L values/air gaps and materials available on request – see Processing remarks on page 7.

Coil former, squared pins

Material: GFR thermosetting plastic (UL 94 V-0, insulation class to IEC 60085: F ≙ max. operating temperature 155 °C), color code black
Sumikon PM 9630® [E41429 (M)], SUMITOMO BAKELITE CO LTD
Solderability: to IEC 60068-2-20, test Ta, method 1 (aging 3): 235 °C, 2 s
Resistance to soldering heat: to IEC 60068-2-20, test Tb, method 1B: 350 °C, 3.5 s
Winding: see Processing notes, 2.1

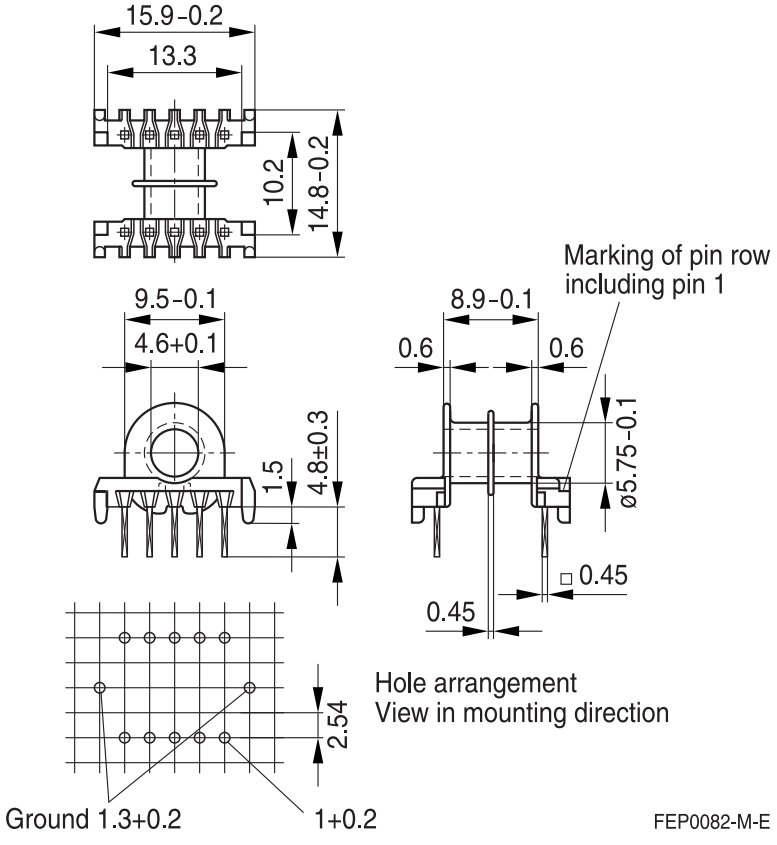
Sections	A_N mm²	l_N mm	A_R value μΩ	Terminals	Ordering code
1	14.3	23.8	57.1	10	B65844W1010D001



Coil former with closed center flange for high-voltage applications

Material: GFR thermosetting plastic (UL 94 V-0, insulation class to IEC 60085: F ≙ max. operating temperature 155 °C), color code black
Sumikon PM 9630® [E41429 (M)], SUMITOMO BAKELITE CO LTD
Solderability: to IEC 60068-2-20, test Ta, method 1 (aging 3): 235 °C, 2 s
Resistance to soldering heat: to IEC 60068-2-20, test Tb, method 1B: 350 °C, 3.5 s
Winding: see Processing notes, 2.1
Pins: Squared pins

Sections	A_N mm²	l_N mm	A_R value μΩ	Terminals	Ordering code
2	13.9	23.8	58.9	10	B65844X1010D002



Mounting assembly

The set comprises a yoke and a clamp

Yoke

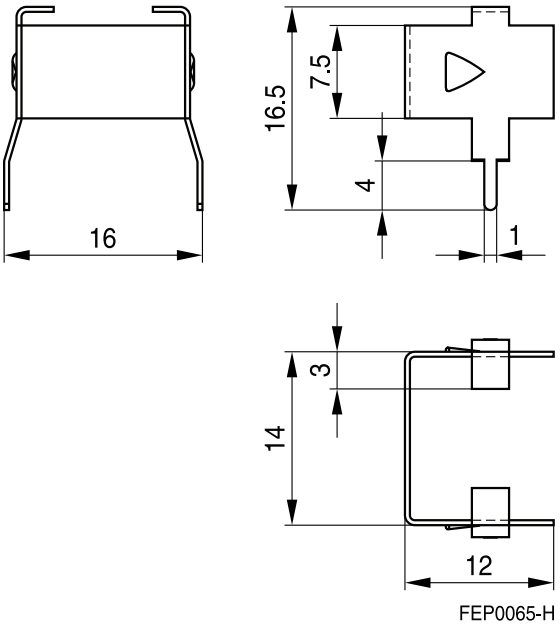
Made of cold rolled steel (0.4 mm) with ground terminal (tinned)

Clamp

Spring clamp, made of bronze (0.3 mm)

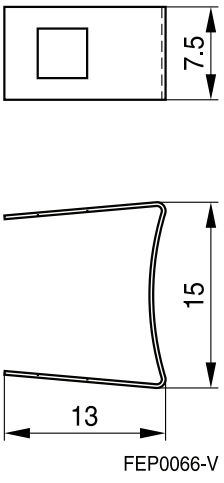
	Ordering code
Complete mounting assembly	B65844S2000X000

Yoke



FEP0065-H

Clamp



FEP0066-V

Mechanical stress and mounting

Ferrite cores have to meet mechanical requirements during assembling and for a growing number of applications. Since ferrites are ceramic materials one has to be aware of the special behavior under mechanical load.

As valid for any ceramic material, ferrite cores are brittle and sensitive to any shock, fast temperature changing or tensile load. Especially high cooling rates under ultrasonic cleaning and high static or cyclic loads can cause cracks or failure of the ferrite cores.

For detailed information see data book, chapter *"General - Definitions, 8.1"*.

Effects of core combination on A_L value

Stresses in the core affect not only the mechanical but also the magnetic properties. It is apparent that the initial permeability is dependent on the stress state of the core. The higher the stresses are in the core, the lower is the value for the initial permeability. Thus the embedding medium should have the greatest possible elasticity.

For detailed information see data book, chapter *"General - Definitions, 8.1"*.

Heating up

Ferrites can run hot during operation at higher flux densities and higher frequencies.

NiZn-materials

The magnetic properties of NiZn-materials can change irreversible in high magnetic fields.

Ferrite Accessories

EPCOS ferrite accessories have been designed and evaluated only in combination with EPCOS ferrite cores. EPCOS explicitly points out that EPCOS ferrite accessories or EPCOS ferrite cores may not be compatible with those of other manufacturers. Any such combination requires prior testing by the customer and will be at the customer‘s own risk.

EPCOS assumes no warranty or reliability for the combination of EPCOS ferrite accessories with cores and other accessories from any other manufacturer.

Processing remarks

The start of the winding process should be soft. Else the flanges may be destroyed.

- Too strong winding forces may blast the flanges or squeeze the tube that the cores can not be mounted any more.
- Too long soldering time at high temperature (>300 °C) may effect coplanarity or pin arrangement.
- Not following the processing notes for soldering of the J-leg terminals may cause solderability problems at the transformer because of pollution with Sn oxyde of the tin bath or burned insulation of the wire. For detailed information see chapter *"Processing notes"*, section 2.2.
- The dimensions of the hole arrangement have fixed values and should be understood as a recommendation for drilling the printed circuit board. For dimensioning the pins, the group of holes can only be seen under certain conditions, as they fit into the given hole arrangement. To avoid problems when mounting the transformer, the manufacturing tolerances for positioning the customers' drilling process must be considered by increasing the hole diameter.

Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. **The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products**. Detailed information can be found on the Internet under www.epcos.com/orderingcodes.

Symbols and terms

Symbol	Meaning	Unit
A	Cross section of coil	mm^2
A_e	Effective magnetic cross section	mm^2
A_L	Inductance factor; $A_L = L/N^2$	nH
A_{L1}	Minimum inductance at defined high saturation ($\triangleq \mu_a$)	nH
A_{min}	Minimum core cross section	mm^2
A_N	Winding cross section	mm^2
A_R	Resistance factor; $A_R = R_{Cu}/N^2$	$\mu\Omega = 10^{-6}\ \Omega$
B	RMS value of magnetic flux density	Vs/m^2, mT
ΔB	Flux density deviation	Vs/m^2, mT
$\hat{B}$	Peak value of magnetic flux density	Vs/m^2, mT
$\Delta\hat{B}$	Peak value of flux density deviation	Vs/m^2, mT
B_{DC}	DC magnetic flux density	Vs/m^2, mT
B_R	Remanent flux density	Vs/m^2, mT
B_S	Saturation magnetization	Vs/m^2, mT
C_0	Winding capacitance	F = As/V
CDF	Core distortion factor	$mm^{-4.5}$
DF	Relative disaccommodation coefficient DF = d/μ_i	
d	Disaccommodation coefficient	
E_a	Activation energy	J
f	Frequency	s^{-1}, Hz
f_{cutoff}	Cut-off frequency	s^{-1}, Hz
f_{max}	Upper frequency limit	s^{-1}, Hz
f_{min}	Lower frequency limit	s^{-1}, Hz
f_r	Resonance frequency	s^{-1}, Hz
f_{Cu}	Copper filling factor	
g	Air gap	mm
H	RMS value of magnetic field strength	A/m
$\hat{H}$	Peak value of magnetic field strength	A/m
H_{DC}	DC field strength	A/m
H_c	Coercive field strength	A/m
h	Hysteresis coefficient of material	10^{-6} cm/A
$h/\mu_i{}^2$	Relative hysteresis coefficient	10^{-6} cm/A
I	RMS value of current	A
I_{DC}	Direct current	A
$\hat{I}$	Peak value of current	A
J	Polarization	Vs/m^2
k	Boltzmann constant	J/K
k_3	Third harmonic distortion	
k_{3c}	Circuit third harmonic distortion	
L	Inductance	H = Vs/A

Symbols and terms

Symbol	Meaning	Unit
$\Delta L/L$	Relative inductance change	H
L_0	Inductance of coil without core	H
L_H	Main inductance	H
L_p	Parallel inductance	H
L_{rev}	Reversible inductance	H
L_s	Series inductance	H
l_e	Effective magnetic path length	mm
l_N	Average length of turn	mm
N	Number of turns	
P_{Cu}	Copper (winding) losses	W
P_{trans}	Transferrable power	W
P_V	Relative core losses	mW/g
PF	Performance factor	
Q	Quality factor ($Q = \omega L/R_s = 1/\tan \delta_L$)	
R	Resistance	Ω
R_{Cu}	Copper (winding) resistance (f = 0)	Ω
R_h	Hysteresis loss resistance of a core	Ω
ΔR_h	R_h change	Ω
R_i	Internal resistance	Ω
R_p	Parallel loss resistance of a core	Ω
R_s	Series loss resistance of a core	Ω
R_{th}	Thermal resistance	K/W
R_V	Effective loss resistance of a core	Ω
s	Total air gap	mm
T	Temperature	°C
ΔT	Temperature difference	K
T_C	Curie temperature	°C
t	Time	s
t_v	Pulse duty factor	
$\tan \delta$	Loss factor	
$\tan \delta_L$	Loss factor of coil	
$\tan \delta_r$	(Residual) loss factor at $H \rightarrow 0$	
$\tan \delta_e$	Relative loss factor	
$\tan \delta_h$	Hysteresis loss factor	
$\tan \delta/\mu_i$	Relative loss factor of material at $H \rightarrow 0$	
U	RMS value of voltage	V
$\hat{U}$	Peak value of voltage	V
V_e	Effective magnetic volume	mm^3
Z	Complex impedance	Ω
Z_n	Normalized impedance $\lvert Z\rvert_n = \lvert Z\rvert / N^2 \times \varepsilon\ (l_e/A_e)$	Ω/mm

Symbols and terms

Symbol	Meaning	Unit
α	Temperature coefficient (TK)	1/K
α_F	Relative temperature coefficient of material	1/K
α_e	Temperature coefficient of effective permeability	1/K
ε_r	Relative permittivity	
Φ	Magnetic flux	Vs
η	Efficiency of a transformer	
η_B	Hysteresis material constant	mT^{-1}
η_i	Hysteresis core constant	$A^{-1}H^{-1/2}$
λ_s	Magnetostriction at saturation magnetization	
μ	Relative complex permeability	
μ_0	Magnetic field constant	Vs/Am
μ_a	Relative amplitude permeability	
μ_{app}	Relative apparent permeability	
μ_e	Relative effective permeability	
μ_i	Relative initial permeability	
μ_p'	Relative real (inductive) component of $\overline{\mu}$ (for parallel components)	
μ_p''	Relative imaginary (loss) component of $\overline{\mu}$ (for parallel components)	
μ_r	Relative permeability	
μ_{rev}	Relative reversible permeability	
μ_s'	Relative real (inductive) component of $\overline{\mu}$ (for series components)	
μ_s''	Relative imaginary (loss) component of $\overline{\mu}$ (for series components)	
μ_{tot}	Relative total permeability derived from the static magnetization curve	
ρ	Resistivity	Ωm^{-1}
$\Sigma l/A$	Magnetic form factor	mm^{-1}
τ_{Cu}	DC time constant $\tau_{Cu} = L/R_{Cu} = A_L/A_R$	s
ω	Angular frequency; $\omega = 2\ \Pi f$	s^{-1}

All dimensions are given in mm.

SMD Surface-mount device

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1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application.** As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified.** In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
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